TOSHIBA INSULATED GATE BIPOLAR TRANSISTOR SILICON N CHANNEL IGBT

# GT10J312, GT10J312(SM)

HIGH POWER SWITCHING APPLICATIONS MOTOR CONTROL APPLICATIONS

- Third-generation IGBT
- Enhancement mode type
- High speed :  $t_f = 0.30 \mu s$  (Max.)
- Low saturation voltage : VCE (sat) = 2.7V (Max.)
- FRD included between emitter and collector

CHARACTERISTIC		SYMBOL	RATING	UNIT	
Collector-Emitter Voltage		V <sub>CES</sub>	600	V	
Gate-Emitter Voltage		V <sub>GES</sub>	±20	V	
Collector Current	DC	Ι <sub>C</sub>	10	A	
	1ms	I <sub>CP</sub>	20	А	
Emitter-Collector Forward Current	DC	١ <sub>F</sub>	10	А	
	1ms	I <sub>FM</sub>	20	А	
Collector Power Dissipation (Tc = 25°C)		PC	60	W	
Junction Temperature		Tj	150	°C	
Storage Temperature Range		T <sub>stg</sub>	-55~150	°C	

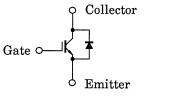
#### Absolute Maximum Ratings (Ta = 25°C)

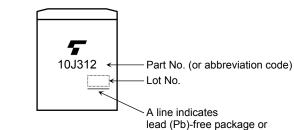
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

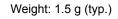
#### **Equivalent Circuit**

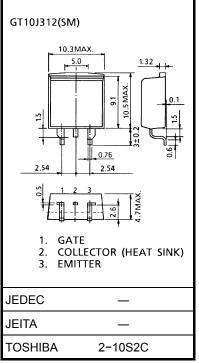






10.3MA> 1.32 10.5MA> 9.1 12.6MIN 1.6MA 0.7 2.54 ± 0.25  $2.54 \pm 0.2$ 2 MA GATE COLLECTOR (HEAT SINK) 2. 3. EMITTER JEDEC JEITA TOSHIBA 2-10S1C







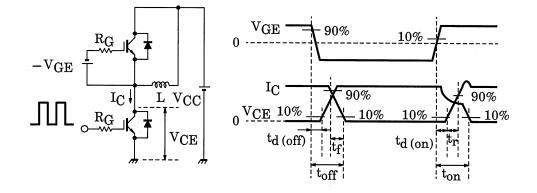
Unit: mm

lead (Pb)-free finish.

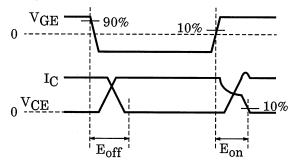
**Electrical Characteristics (Ta = 25°C)** 

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Gate Leakage Current		IGES	$V_{GE}$ = ±20V, $V_{CE}$ = 0	_	_	±500	nA
Collector Cut-Off Current		ICES	V <sub>CE</sub> = 600V, V <sub>GE</sub> = 0	_	_	1.0	mA
Gate-Emitter Cut-Off Voltage		V <sub>GE (OFF)</sub>	I <sub>C</sub> = 1mA, V <sub>CE</sub> = 5V	5.0	_	8.0	V
Collector-Emitter S	Saturation Voltage	V <sub>CE (sat)</sub>	I <sub>C</sub> = 10A, V <sub>GE</sub> = 15V	_	2.1	2.7	V
Input Capacitance		Cies	V <sub>CE</sub> = 20V, V <sub>GE</sub> = 0, f = 1MHz	_	720	_	pF
Switching Time	Rise Time	tr	Inductive Load $V_{CC} = 300V$ , $I_C = 10A$ $V_{GG} = \pm 15V$ , $R_G = 100\Omega$ (Note 1)	_	0.12	_	μs
	Turn-On Time	t <sub>on</sub>		_	0.40	_	
	Fall Time	tf		_	0.15	0.30	
	Turn-Off Time	t <sub>off</sub>			0.40	_	
Peak Forward Voltage		V <sub>F</sub>	I <sub>F</sub> = 10A, V <sub>GE</sub> = 0	_	_	2.0	V
Reverse Recovery Time		t <sub>rr</sub>	I <sub>F</sub> = 10A, di / dt = −100A / µs	_	_	200	ns
Thermal Resistance (IGBT)		R <sub>th (j−c)</sub>	—	—	_	2.08	°C / W
Thermal Resistance (Diode)		R <sub>th (j−c)</sub>	—	—	_	3.76	°C / W

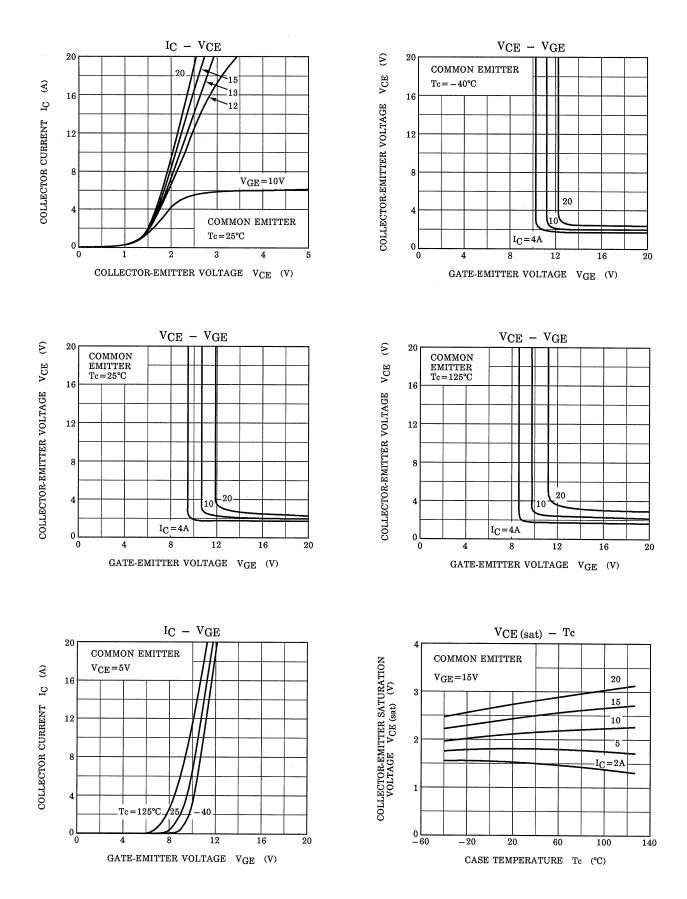
Note 1: Switching time measurement circuit and input / output waveforms



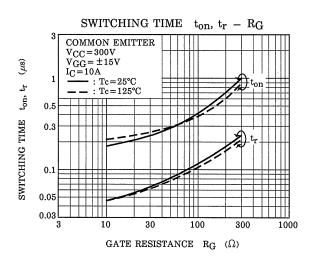
Switching loss measurement waveforms

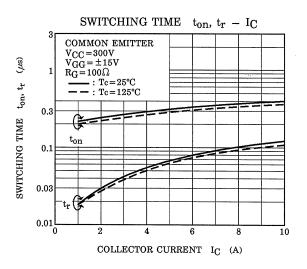


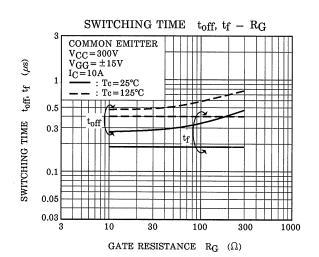
## **TOSHIBA**

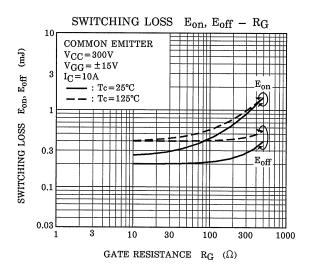


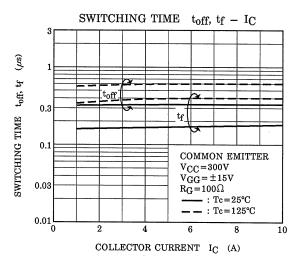
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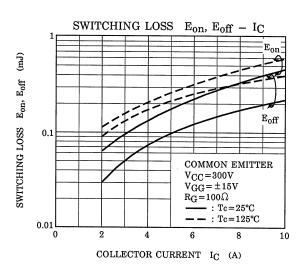




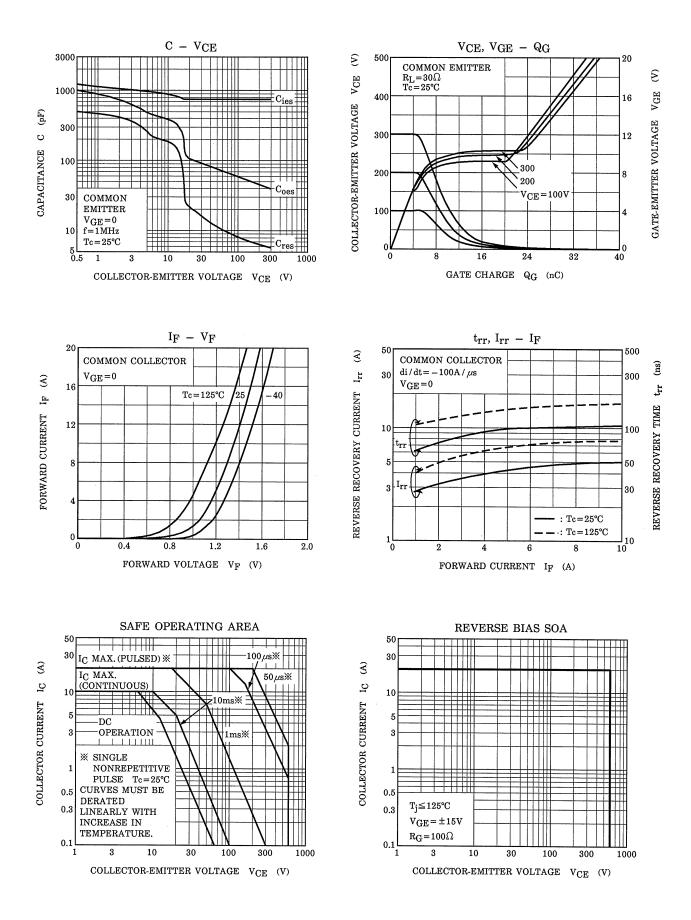


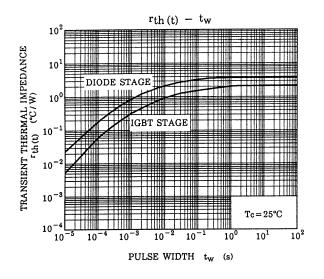






## TOSHIBA





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